## **ON Semiconductor**

### Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,



ON Semiconductor

# FGA25N120ANTDTU 1200 V, 25 A NPT Trench IGBT

#### **Features**

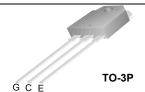
- · NPT Trench Technology, Positive Temperature Coefficient
- Low Saturation Voltage: V<sub>CE(sat), typ</sub> = 2.0 V
   Q I<sub>C</sub> = 25 A and T<sub>C</sub> = 25°C
- Low Switching Loss:  $E_{off, typ}$  = 0.96 mJ @ I<sub>C</sub> = 25 A and T<sub>C</sub> = 25°C
- · Extremely Enhanced Avalanche Capability

### **Description**

Using ON Semiconductor's proprietary trench design and advanced NPT technology, the 1200V NPT IGBT offers superior conduction and switching performances, high avalanche ruggedness and easy parallel operation. This device is well suited for the reso-nant or soft switching application such as induction heating, microwave oven.

### **Applications**

· Induction Heating, Microwave Oven





### **Absolute Maximum Ratings**

Symbol	Description		Ratings	Unit
V <sub>CES</sub>	Collector-Emitter Voltage		1200	V
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V
1	Collector Current	@ T <sub>C</sub> = 25°C	50	A
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100°C	25	A
I <sub>CM (1)</sub>	Pulsed Collector Current		90	A
1	Diode Continuous Forward Current	@ T <sub>C</sub> = 25°C	50	A
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 100°C	25	A
I <sub>FM</sub>	Diode Maximum Forward Current		150	A
0	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	312	W
$P_{D}$	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	125	W
$T_J$	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

#### Notes

(1) Repetitive rating: Pulse width limited by max. junction temperature

#### **Thermal Characteristics**

Symbol	Symbol Parameter		Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction-to-Case		0.4	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		2.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

## **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGA25N120ANTDTU-F109	FGA25N120ANTDTU	TO-3PN	Tube	N/A	N/A	30

## Electrical Characteristics of the IGBT $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V			3	mA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$			± 250	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	I <sub>C</sub> = 25 mA, V <sub>CE</sub> = V <sub>GE</sub>	3.5	5.5	7.5	V
- (- )		I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V		2.0		V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V, T <sub>C</sub> = 125°C		2.15		V
		I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V		2.65		V
D				•		
C <sub>ies</sub>	Characteristics Input Capacitance			3700		pF
C <sub>oes</sub>	Output Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$ f = 1 MHz		130		pF
C <sub>res</sub>	Reverse Transfer Capacitance			80		pF
t <sub>d(on)</sub>	Characteristics Turn-On Delay Time			50		ns
$t_{d(on)}$	Turn-On Delay Time			50		ns
t <sub>r</sub>	Rise Time			60		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{CC}$ = 600 V, $I_{C}$ = 25 A, $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V, Inductive Load, $T_{C}$ = 25°C		190		ns
t <sub>f</sub>	Fall Time			100		ns
E <sub>on</sub>	Turn-On Switching Loss			4.1		mJ
E <sub>off</sub>	Turn-Off Switching Loss			0.96		mJ
E <sub>ts</sub>	Total Switching Loss			5.06		mJ
$t_{d(on)}$	Turn-On Delay Time			50		ns
t <sub>r</sub>	Rise Time			60		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 600 V, I <sub>C</sub> = 25 A,		200		ns
t <sub>f</sub>	Fall Time	$R_G = 10\Omega$ , $V_{GE} = 15$ V,  Inductive Load, $T_C = 125^{\circ}$ C		154		ns
E <sub>on</sub>	Turn-On Switching Loss			4.3		mJ
E <sub>off</sub>	Turn-Off Switching Loss			1.5		mJ
				5.8		mJ
E <sub>ts</sub>	Total Switching Loss			0.0		1110
	Total Switching Loss Total Gate Charge			200		nC
E <sub>ts</sub> Q <sub>g</sub> Q <sub>ge</sub>	•	V <sub>CE</sub> = 600 V, I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V			-	

# Electrical Characteristics of DIODE T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V	Diada Faryard Valtaga	L = 25 A	T <sub>C</sub> = 25°C		2.0	3.0	V
V <sub>FM</sub> Diode	Diode Forward Voltage	I <sub>F</sub> = 25 A	T <sub>C</sub> = 125°C		2.1		V
, ,	Diode Reverse Recovery Time	$di_F/dt = 200 A/\mu s$	T <sub>C</sub> = 25°C		235	350	ns
t <sub>rr</sub>			T <sub>C</sub> = 125°C		300		
1	Diode Peak Reverse Recovery Current		T <sub>C</sub> = 25°C		27	40	Α
			T <sub>C</sub> = 125°C		31		
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25°C		3130	4700	nC
			T <sub>C</sub> = 125°C		4650		

### **Typical Performance Characteristics**

**Figure 1. Typical Output Characteristics** 

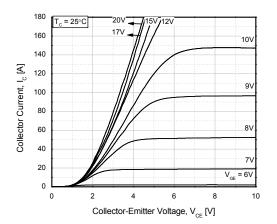


Figure 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

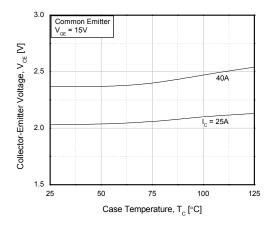


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

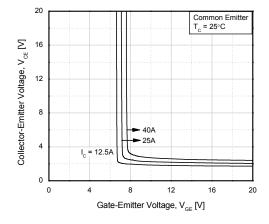


Figure 2. Typical Saturation Voltage Characteristics

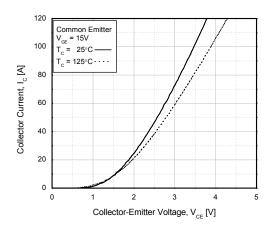


Figure 4. Saturation Voltage vs.  $V_{GE}$ 

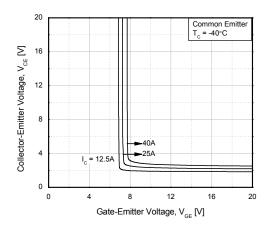
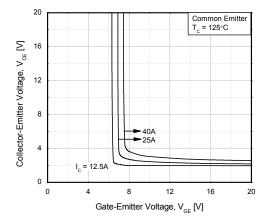


Figure 6. Saturation Voltage vs. V<sub>GE</sub>



### Typical Performance Characteristics (Continued)

Figure 7. Capacitance Characteristics

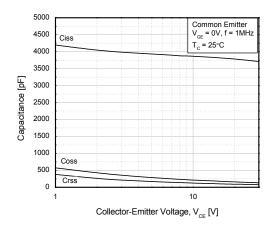


Figure 8. Turn-On Characteristics vs. Gate Resistance

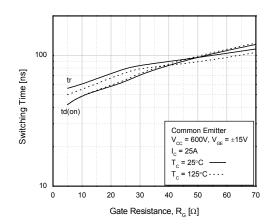


Figure 9. Turn-Off Characteristics vs.
Gate Resistance

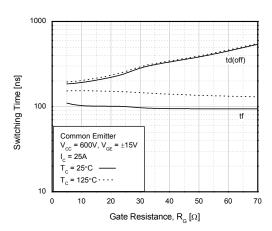


Figure 10. Switching Loss vs. Gate Resistance

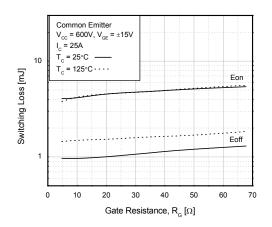


Figure 11. Turn-On Characteristics vs. Collector Current

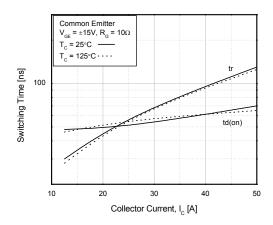
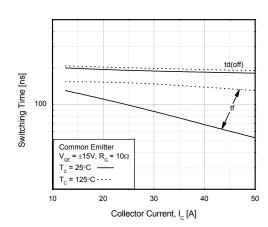


Figure 12. Turn-Off Characteristics vs. Collector Current



### Typical Performance Characteristics (Continued)

Figure 13. Switching Loss vs. Collector Current

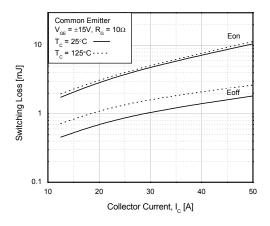


Figure 14. Gate Charge Characteristics

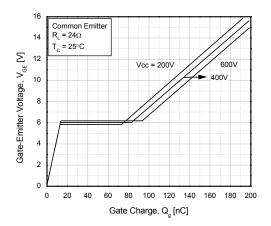


Figure 15. SOA Characteristics

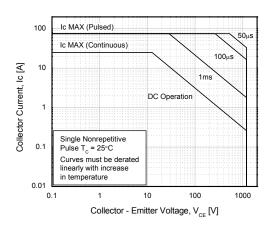


Figure 16. Turn-Off SOA

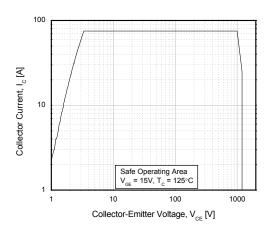
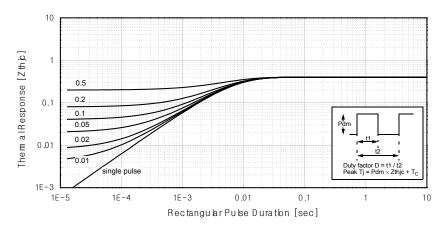


Figure 17. Transient Thermal Impedance of IGBT



## Typical Performance Characteristics (Continued)

#### **Figure 18. Forward Characteristics**

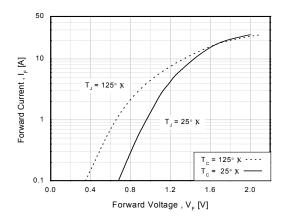
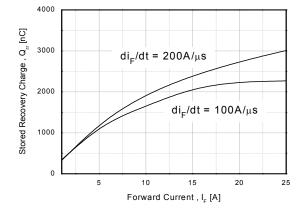


Figure 20. Stored Charge



**Figure 19. Reverse Recovery Current** 

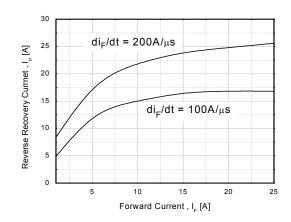
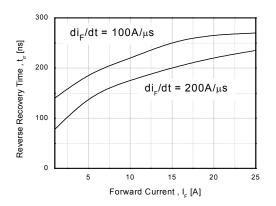
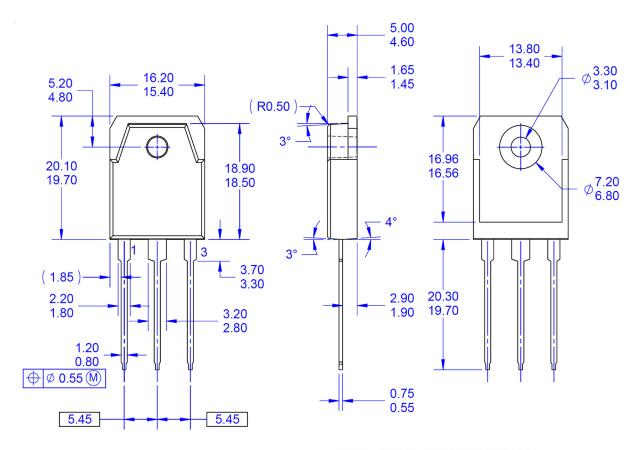
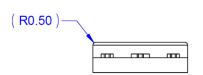


Figure 21. Reverse Recovery Time



#### **Mechanical Dimensions**





#### NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO EIAJ
- SC-65 PACKAGING STANDARD. ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSION AND TOLERANCING PER ASME14.5-2009.
- DIMENSIONS ARE EXCLUSSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSSIONS.
  DRAWING FILE NAME: TO3PN03AREV1.
- FAIRCHILD SEMICONDUCTOR.

Figure 22. TO3PN, 3-Lead, Plastic, EIAJ SC-65

Package drawings are provided as a service to customers considering ON Semiconductor components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a ON Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of ON Semiconductor's worldwide terms and conditions, specif-ically the warranty therein, which covers ON Semiconductor products.

ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for IGBT Transistors category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

 748152A
 APT20GT60BRDQ1G
 APT50GT60BRG
 NGTB10N60FG
 STGFW20V60DF
 APT30GP60BG
 APT45GR65B2DU30

 GT50JR22(STA1ES)
 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
 NGTG15N120FL2WG
 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

 IKZA40N65RH5XKSA1
 IKFW75N65ES5XKSA1
 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

 IKFW60N65ES5XKSA1
 IMBG120R090M1HXTMA1
 IMBG120R220M1HXTMA1
 XD15H120CX1
 XD25H120CX0
 XP15PJS120CL1B1

 IGW30N60H3FKSA1
 STGWA8M120DF3
 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD\_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1